



4-12-04

To the Honorable
Please record this

102720465

ks:

...thereof.

1. Name of conveying party(ies):
Xiaofan Zhu

2. Name and address of receiving party(ies):

Name:

Nippon Sheet Glass Co., Ltd.

Address:

4-7-28, Kitahama, Chuou-ku
Osaka-shi, Osaka 541-8559 Japan

Additional name(s) of conveying party(ies)
attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

Additional name(s) & addresses attached?

Yes No

Execution Date: February 27, 2002

OFFICE OF PUBLIC RECORDS
2004 APR 12 AM 10:35
FINANCE SECTION

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)
10/093,019

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence
concerning document should be mailed:

Name: David M. Crompton

Address: CROMPTON, SEAGER & TUFTE, LLC
1221 Nicollet Avenue, Suite 800
Minneapolis, MN 55403-2420

6. Total number of applications and patents
involved: 1

7. Total fee (37 CFR 3.41). \$40.00
 Enclosed
 Authorized to be charged to deposit account

8. Deposit Account Number: 50-0413
(Attach duplicate copy of this page if
paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David M. Crompton
Name of Person Signing

David M. Crompton
Signature

4/8/04
Date

Total number of pages comprising cover sheet, attachments and document: 2

OMB No. 0651-0011 (exp. 4/94)

Document ID No. 102512025

Docket No.: 1018.1133101

04/13/2004 6T0M11 00000074 10093019
01 FC:8021 40.00 0P

ASSIGNMENT OF APPLICATION

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the undersigned inventor(s) hereby:

1) Sell(s), assign(s) and transfer(s) to NIPPON SHEET GLASS CO., LTD. (hereinafter referred to as "ASSIGNEE"), which has a business office at 4-7-28, Kitahama, Chuou-ku, Osaka-shi, Osaka 541-8559 Japan, the entire right, title, and interest in any and all inventions and improvements disclosed in, application(s) based upon, and Patent(s) granted upon the information which is disclosed in the application entitled:

OPTICAL MODULE AND METHOD FOR ASSEMBLING AN OPTICAL MODULE

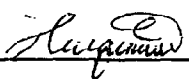
(File No. _____) for which I (we) have executed an application for a United States Letters Patent on _____ (Application Serial No. _____ filed on _____.)


2) Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application, or any division, continuation, substitute or reissue thereof, to the ASSIGNEE.

3) Agree to execute all papers and documents and perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative applications thereof and/or the enforcement of patents resulting from such applications.

Signed on the date(s) indicated beside my (our) signature(s).

1)  Date: February 27, 2002
Name: ZHU Xiaofan

Witness:  Date: February 27, 2002
Name: _____

Witness:  Date: February 27, 2002
Name: _____